SURFBOARDS®



THE BREADBOARDING MEDIUM FOR **SURFACE MOUNT** TM

33000 SERIES APPLICATION SPECIFIC ADAPTERS

IDS33115

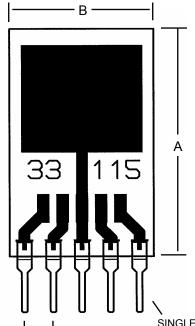
REV 1-2012

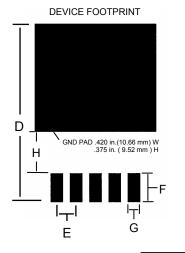
MODEL 33115

ACCEPTS
THESE
DEVICES
PARTIAL
LISTING

TO-263-5L
LINEAR 5-LEAD DD PKG.
MICREL 5LSPAK
ON SEMI D2PAK 5-L

ALWAYS CONSULT DEVICE DATA SHEET TO INSURE PROPER FIT





PINS ON .1 in CENTERS PROVIDE COMPATIBILITY WITH BREADBOARDS AND SOCKETS.

FOR PROTOTYPING, DEVICE EVALUATION OR TEST, SMD TO THROUGH HOLE CONVERSION.

NOTE: CIRCUIT FOILS AND OUTPUT PINS MAY NOT BE SUITABLE FOR OPERATION AT HIGHEST RATED DEVICE CURRENT. EXTREME TEMPERATURE RISE MAY CAUSE FAILURE.

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SINGLE-IN-LINE (SIP) PINS
ON .1 in. CENTERS SEE PIN
SPECIFICATIONS.

FIG.	INCHES	ММ	NOTE:
Α	.800	20.32	BOARD HEIGHT +5mm .020in.
В	.500	12.70	BOARD WIDTH +5mm .020in.
С	.100	2.54	SIP PIN SPACE +20mm .008in.
D	.625	15.87	PAD (DEVICE) MAX
E	.067	1.70	DEVICE LEAD PITCH
F	.100	2.54	PAD LENGTH
G	.042	.1.06	PAD WIDTH
Н	.150	3.81	GAP



PIN SPECIFICATIONS / TOLERANCES

In Inches
A = .062 +- .006
B = .130 +- .010
C = .100 +- .005
D = .020 +- .004
E = .031 +-.005

BOARD SPECIFICATIONS

BOARD MATERIAL: .8mm, +-.13mm .031in+-..005 in. Thick G-10 FR-4 Glass Epoxy or equivalent. CIRCUITS: 1 oz. Copper with RoHS compliant Lead Free solder coating. Patten Position on board +-.5mm .020in.

TOLERANCES: If not noted are +- 20%. Nominal values are given. Controlling unit is Millimeters. Values rounded to nearest decimal. Slight Variations due to manufacturing process can occur.

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